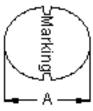
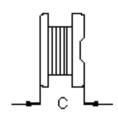
Inductor



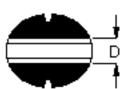
Configurations and Dimensions

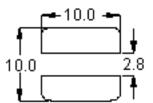




Top View

Side View





Suggest PCB Layout

Bottom View

Dimensions : Millimetres

Marking: 821

Electrical Characteristics (at 25°C)

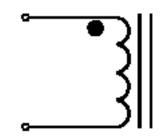
Test Condition		
1 KHz 1 V	L	820 µH ±10%
at 25°C	DCR	2.55Ω (Max.)
1 KHz 1 V Ims = 0.24 A	ΔΤ	Temperature rise 40°C (Max.)

Operating temperature : -55°C to +130°C

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RoHS Compliant

Schematic Diagram



Note:

- 1. Wire Ø0.17mm × 1P 2UEF1/U 155°C
- 2. 134.5TS (Reference)

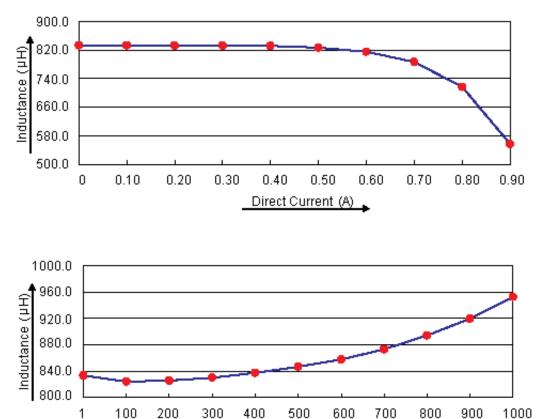
А	9.8 mm	(Max.)
С	5.8 mm	(Max.)
D	2.9 mm	(Ref.)

Test Data for Mechanical

Test Item	A mm	C mm	D mm
Specification	9.8 (Max.)	5.8 (Max.)	2.9 (Ref.)
1	9.56	5.54	2.81
2	9.54	5.61	2.83
3	9.52	5.57	2.79
4	9.49	5.53	2.76
5	9.51	5.58	2.84
Average	9.52	5.57	2.81



Inductor



Frequency (KHz)

Electric Characteristics

Test	Data	for	Electrical
1000	Bata		LIVULIUUI

Test Item	L µH	DCR Ω	ΔΤ
Condition	1 KHz 1 V	at 25°C	1 KHz 1 V I _{rms} = 0.24 A
Specification	820 ±10%	2.55 (Max.)	Temperature rise 40°C (Max.)
1	838.6	2.12	
2	833.9	2.13	
3	832.7	2.13	ОК
4	834.8	2.12	
5	836.5	2.12	
Average	835.3	2.12	ОК

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Inductor

Reliability Test

Test Item	Specifications		Test Method and Remarks	
Operating Temperature Range	-55°C to +130°C		Including temperature ri self-generated heat.	se due to
Storage Condition	Ambient Temperature: 0°C to 40°CHumidity: Below 70% RH		To maintain the solderability of terminal electrodes, care must be taken to control temperature and humidity in the storage area.	
			According to J-STD-020)B level 3
			Test Condition	: 60°C 60% RH
	Appearance	: No abnormality	Test Duration	: 40 hrs
Moisture Sensitivity DCR Change Inductance Chang	DCR Change Inductance Change	No damage : Within ±20% : Within ±20%	Recovery	: 1 to 2 hours of recovery under the standard condition after the removal from the test chamber.
	All termination shall exhibit a continuous solder coating free from defects for a minimum of 90% of the surface area of any individual lead.		According to J-STD-002	2B
			Steam Aging Category	: 97°C 98% RH
Solderability			Steam Aging Duration	: 8 hrs
Conderability			Solder	: Lead-free solder
			Solder Temperature	: 260 ±5°C
			Dip Time	: 5 +0 / -0.5 s

Material List

No.	ltem	Material Description
1	Core	K22 DRM 9.5 × 5.5 RB-R B = 4.5 F = 3
2	Wire	Ø0.17 mm × 1P 2UEF1/U (155°C)
3	Solder (Lead-free)	Sn99.3% / Cu0.7%

Part Number Table

Description	Part Number
Inductor, 820µH, 10%, SMD	MCSDC1006-821KU

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